



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	IPI60R099CP	<b>Issued</b>	16. May 2021
<b>MA#</b>	MA005402868		
<b>Package</b>	PG-TO262-3-22	<b>Weight*</b>	1578.54 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	15.501	0.98	0.98	9820	9820
leadframe	inorganic material	phosphorus	7723-14-0	0.255	0.02		162	
	non noble metal	iron	7439-89-6	0.851	0.05		539	
	non noble metal	copper	7440-50-8	849.682	53.84	53.91	538271	538972
wire	non noble metal	aluminium	7429-90-5	3.209	0.20	0.20	2033	2033
encapsulation	organic material	carbon black	1333-86-4	2.897	0.18		1835	
	miscellaneous	miscellaneous	-	2.897	0.18		1835	
	organic material	phenol formaldehyde resin	9003-35-4	34.762	2.20		22022	
	inorganic material	silicondioxide	14808-60-7	46.350	2.94		29362	
	non noble metal	metal hydroxide	-	46.350	2.94		29362	
	plastics	epoxy resin	29690-82-2	69.524	4.40		44043	
	inorganic material	silicondioxide	60676-86-0	376.590	23.86	36.70	238568	367027
leadfinish	non noble metal	tin	7440-31-5	15.198	0.96	0.96	9628	9628
plating	non noble metal	nickel	7440-02-0	1.651	0.10	0.10	1046	1046
solder	non noble metal	antimony	7440-36-0	0.648	0.04		410	
	noble metal	silver	7440-22-4	1.619	0.10		1026	
	non noble metal	tin	7440-31-5	4.210	0.27	0.41	2667	4103
heatspreader	inorganic material	phosphorus	7723-14-0	0.032			20	
	non noble metal	iron	7439-89-6	0.106	0.01		67	
	non noble metal	copper	7440-50-8	106.210	6.73	6.74	67284	67371
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

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